

NPN 9 GHz wideband transistor

VN054

FEATURES

- . Very high power gain
- . Low noise figure
- . High transition frequency
- . Emitter is thermal lead
- . Low feedback capacitance.

APPLICATIONS

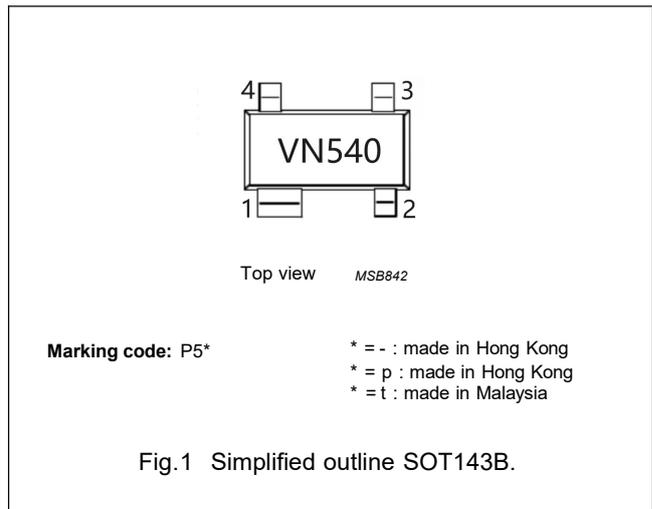
- . RF front end
- . Wideband applications, e.g. analog and digital cellular telephones, cordless telephones (PHS, DECT, etc.)
- . Radar detectors
- . Pagers
- . Satellite television tuners (SATV)
- . High frequency oscillators.

DESCRIPTION

NPN double polysilicon wideband transistor with buried layer for low voltage applications in a plastic, 4-pin dual-emitter SOT143B package.

PINNING

| PIN | DESCRIPTION |
|-----|-------------|
| 1 | collector |
| 2 | emitter |
| 3 | base |
| 4 | emitter |



QUICK REFERENCE DATA

| SYMBOL | PARAMETER | CONDITIONS | MIN. | TYP. | MAX. | UNIT |
|------------------|---------------------------|--|------|------|------|------|
| V _{CBO} | collector-base voltage | open emitter | — | — | 20 | V |
| V _{CEO} | collector-emitter voltage | open base | — | — | 15 | V |
| I _C | collector current (DC) | | — | 120 | | mA |
| P _{tot} | total power dissipation | T _s < 103 °C | — | — | 400 | mW |
| h _{FE} | DC current gain | I _C = 20 mA; V _{CE} = 6 V; T _j = 25 °C | 60 | 120 | 250 | |
| C _{re} | feedback capacitance | I _C = 0; V _{CE} = 8 V; f = 1 MHz | — | 0.5 | — | pF |
| f _T | transition frequency | I _C = 40 mA; V _{CE} = 8 V; f = 1 MHz; T _{amb} = 25 °C | — | 9 | — | GHz |
| G _{max} | maximum power gain | I _C = 40 mA; V _{CE} = 8 V; f = 900 MHz; T _{amb} = 25 °C | — | 18 | — | dB |
| F | noise figure | I _C = 40 mA; V _{CE} = 8 V; f = 900 MHz; T _{amb} = 25 °C | — | 1.9 | — | dB |

CAUTION

This product is supplied in anti-static packing to prevent damage caused by electrostatic discharge during transport and handling.

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LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 134).

| SYMBOL | PARAMETER | CONDITIONS | MIN. | MAX. | UNIT |
|------------------|--------------------------------|--|------|------|------|
| V _{CB0} | collector-base voltage | open emitter | - | 20 | V |
| V _{CEO} | collector-emitter voltage | open base | - | 15 | V |
| V _{EB0} | emitter-base voltage | open collector | - | 2.5 | V |
| I _C | collector current (DC) | | - | 120 | mA |
| P _{tot} | total power dissipation | T _s < 103 °C; note 1; see Fig.2 | - | 400 | mW |
| T _{stg} | storage temperature | | -65 | +150 | °C |
| T _j | operating junction temperature | | - | 150 | °C |

Note

1. T_s is the temperature at the soldering point of the emitter pins.

THERMAL CHARACTERISTICS

| SYMBOL | PARAMETER | VALUE | UNIT |
|---------------------|---|-------|------|
| R _{th j-s} | thermal resistance from junction to soldering point | 350 | K/W |

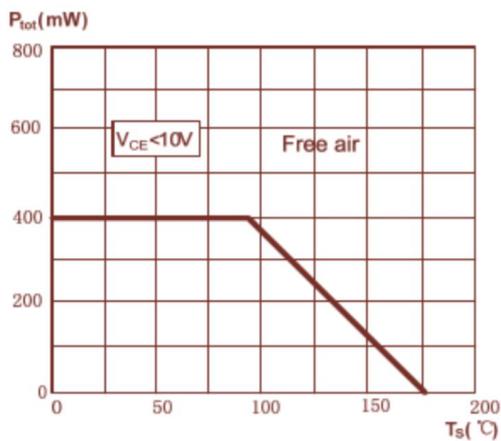


Fig.2 Power derating curve.

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CHARACTERISTICS

$T_j = 25 \text{ }^\circ\text{C}$ unless otherwise specified.

| SYMBOL | PARAMETER | CONDITIONS | MIN. | TYP. | MAX. | UNIT |
|---------------|---------------------------------------|--|------|------|------|------|
| $V_{(BR)CBO}$ | collector-base breakdown voltage | $I_C = 2.5 \text{ } \mu\text{A}; I_E = 0$ | 20 | — | — | V |
| $V_{(BR)CEO}$ | collector-emitter breakdown voltage | $I_C = 1 \text{ mA}; I_B = 0$ | 15 | — | — | V |
| $V_{(BR)EBO}$ | emitter-base breakdown voltage | $I_E = 2.5 \text{ } \mu\text{A}; I_C = 0$ | 2.5 | — | — | V |
| I_{CBO} | collector-base leakage current | $I_E = 0; V_{CB} = 6 \text{ V}$ | — | — | 50 | nA |
| h_{FE} | DC current gain | $I_C = 20 \text{ mA}; V_{CE} = 6 \text{ V};$ see Fig.3 | 60 | 120 | 250 | |
| C_c | collector capacitance | $I_E = I_E = 0; V_{CB} = 8 \text{ V}; f = 1 \text{ MHz}$ | — | 0.9 | — | pF |
| C_e | emitter capacitance | $I_C = I_C = 0; V_{EB} = 0.5 \text{ V}; f = 1 \text{ MHz}$ | — | 2.0 | — | pF |
| C_{re} | feedback capacitance | $I_C = 0; V_{CB} = 8 \text{ V}; f = 1 \text{ MHz};$ see Fig.4 | — | 0.5 | — | pF |
| f_T | transition frequency | $I_C = 40 \text{ mA}; V_{CE} = 8 \text{ V}; f = 1 \text{ MHz};$ $T_{amb} = 25 \text{ }^\circ\text{C};$ see Fig.5 | — | 9 | — | GHz |
| G_{max} | maximum power gain; note 1 | $I_C = 40 \text{ mA}; V_{CE} = 8 \text{ V}; f=900\text{MHz};$ $T_{amb} = 25 \text{ }^\circ\text{C};$ see Figs 7 and 8 | — | 18 | — | dB |
| $ S_{21} ^2$ | insertion power gain | $I_C = 40 \text{ mA}; V_{CE} = 8 \text{ V}; f=900\text{MHz};$ $T_{amb} = 25 \text{ }^\circ\text{C};$ see | — | 16 | — | dB |
| F | noise figure | $I_C = 10 \text{ mA}; V_{CE} = 8 \text{ V}; f=900$ MHz; $T_{amb} = 25 \text{ }^\circ\text{C};$ see | — | 1.3 | — | dB |
| | | $I_C = 40 \text{ mA}; V_{CE} = 8 \text{ V}; f=900$ MHz; $T_{amb} = 25 \text{ }^\circ\text{C};$ see | — | 1.9 | — | dB |
| PL_1 | output power at 1 dB gain compression | $I_C = 40\text{mA}; V_{CE} = 8 \text{ V}; f=900\text{MHz};$ $Z_S = Z_L= 75\Omega; T_{amb} = 25 \text{ }^\circ\text{C};$ | — | 21 | — | dBm |
| ITD | third order intercept point | $I_C = 40\text{mA}; V_{CE} = 8\text{V}; f_p=900\text{MHz};$ $f_q=900\text{MHz}; R_L=50\Omega; T_{amb}=25 \text{ }^\circ\text{C};$ | — | 34 | — | dBm |

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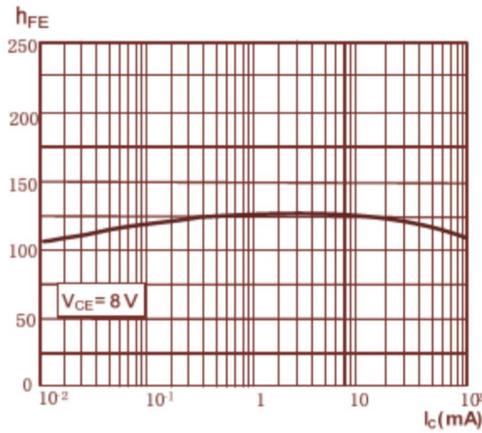


Fig.3 DC current gain as a function of collector current; typical values.

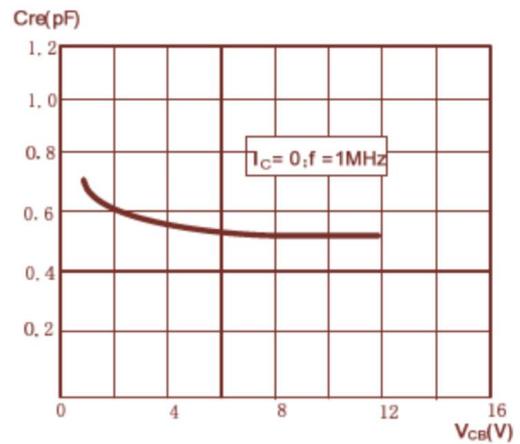


Fig.4 Feedback capacitance as a function of collector-base voltage; typical values.

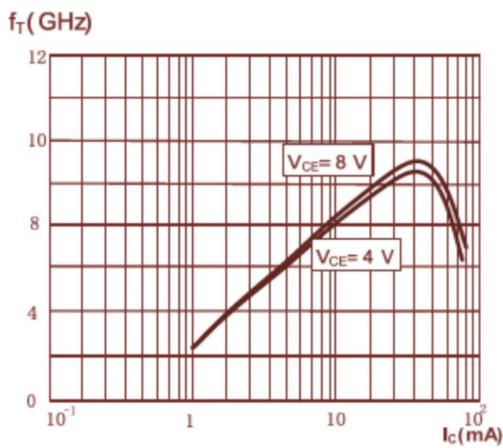


Fig.5 Transition frequency as a function of collector current; typical values.

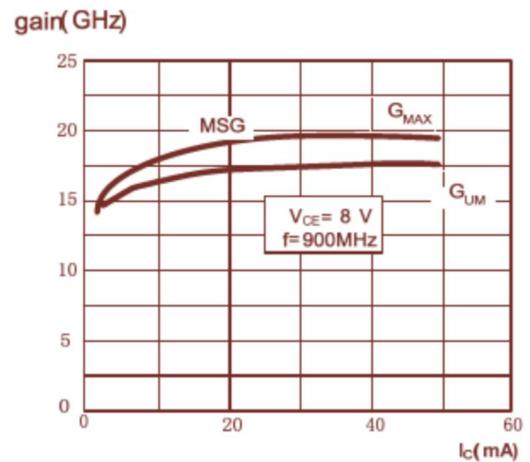


Fig.6 Maximum stable gain as a function of collector current; typical values.

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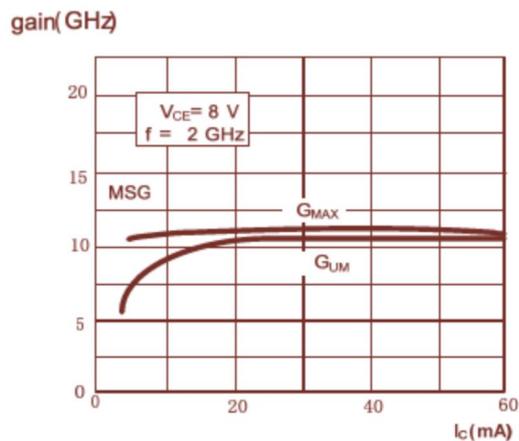


Fig.7 Gain as a function of collector current; typical values.

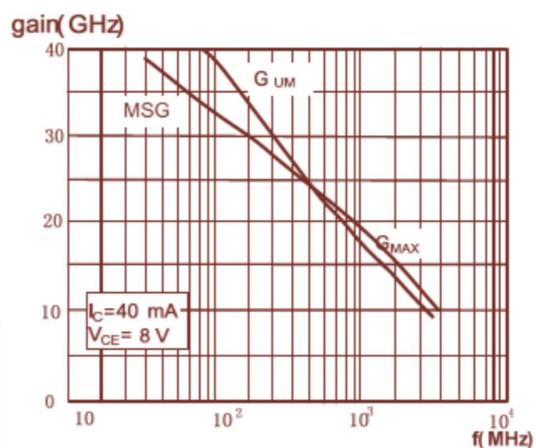


Fig.8 Gain as a function of frequency; typical values.

PACKAGE OUTLINE

Plastic surface-mounted package; reverse pinning; 4 leads

SOT143B

